

### **Maximum Ratings** (@TA = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	B170/B	B180/B	B190/B	B1100/B	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	VRRM VRWM VR	70	80	90	100	V
RMS Reverse Voltage	V <sub>R</sub> (RMS)	49	56	63	70	V
Average Rectified Output Current @ T <sub>T</sub> = +125°C	lo	lo 1.0			Α	
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	30		А		
Repetitive Peak Reverse Current	IRRM	1.0			Α	

# **Thermal Characteristics**

Characteristic	Symbol	B170/B	B180/B	B190/B	B1100/B	Unit
Typical Thermal Resistance Junction to Terminal (Note 5)	Rөлт	25				°C/W
Operating and Storage Temperature Range	TJ, TSTG	-65 to +150				°C

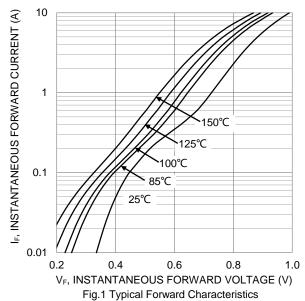
# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

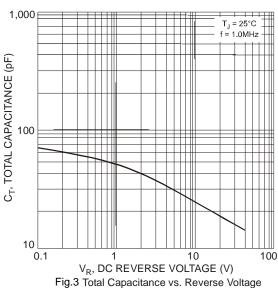
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	V <sub>F</sub>	_	_	0.79 0.69		I <sub>F</sub> = 1.0A, T <sub>A</sub> = +25°C I <sub>F</sub> = 1.0A, T <sub>A</sub> = +100°C
Leakage Current (Note 6)	IR	_	_	0.5 5.0	mA	@ Rated V <sub>R</sub> , T <sub>A</sub> = +25°C @ Rated V <sub>R</sub> , T <sub>A</sub> = +100°C
Total Capacitance	Ст	_	_	80	pF	$V_R = 4V$ , $f = 1MHz$

Notes:

- 5. Valid provided that terminals are kept at ambient temperature.
- 6. Short duration pulse test used to minimize self-heating effect.







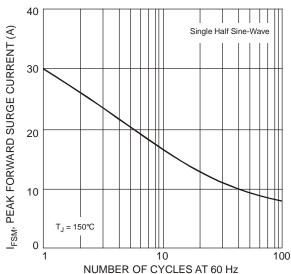
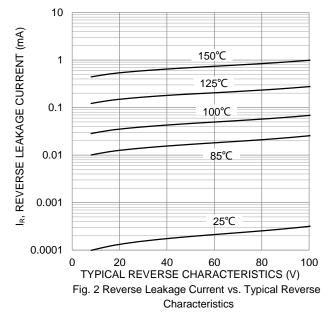
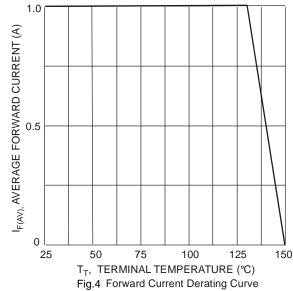


Fig.5 Max Non-Repetitive Peak Forward Surge Current

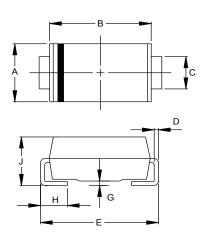






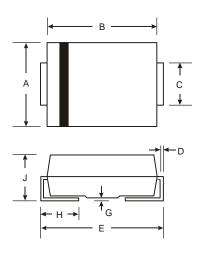
# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.





SMA				
Dim	Min	Max		
Α	2.29	2.92		
В	4.00	4.60		
C	1.27	1.63		
D	0.15	0.31		
E	4.80	5.59		
G	0.05	0.20		
Н	0.76	1.52		
J	1.96	2.40		
All Dimensions in mm				



SMB

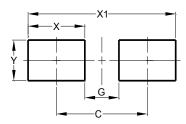
SMB				
Dim	Min	Max		
Α	3.30	3.94		
В	4.06	4.57		
C	1.96	2.21		
D	0.15	0.31		
Е	5.00	5.59		
G	0.05	0.20		
Η	0.76	1.52		
٦	2.00	2.50		
All Dimensions in mm				



# **Suggested Pad Layout**

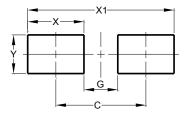
Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SMA



Dimensions	Value (in mm)
C	4.00
G	1.50
X	2.50
X1	6.50
Y	1.70

#### **SMB**



Dimensions	Value (in mm)
С	4.30
G	1.80
Х	2.50
X1	6.80
Υ	2.30



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  - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
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